

PMEG100T050ELPE

100 V, 5 A low leakage current Trench MEGA Schottky barrier rectifier

3 December 2020

Product data sheet

1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- · High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- AEC-Q101 qualified

3. Applications

- · High efficiency DC-to-DC conversion
- · Automotive LED lighting
- Switch mode power supply
- · Freewheeling application
- Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; square wave; f = 20 kHz; $T_{sp} \le$ 163 °C		-	-	5	А
V_R	reverse voltage	T _j = 25 °C		-	-	100	V
V _F	forward voltage	I _F = 5 A; pulsed; T _j = 25 °C	[1]	-	750	810	mV
I _R	reverse current	V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.4	2.5	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.6	3	mA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode	5	⊬ F≥ A
2	Α	anode		A aaa-009063
3	К	cathode	2	aaa-009003
			CFP15B (SOT1289B)	

6. Ordering information

Table 3. Ordering information

Type number	Package							
	Name	Description	Version					
PMEG100T050ELPE	CFP15B	plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; $5.8 \times 4.3 \times 0.95$ mm body	SOT1289B					

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG100T050ELPE	100T
	L05E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	δ = 1; T _{sp} ≤ 159 °C		-	7	А
I _{F(AV)}	average forward current	δ = 0.5; square wave; f = 20 kHz; T _{sp} ≤ 163 °C		-	5	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	100	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

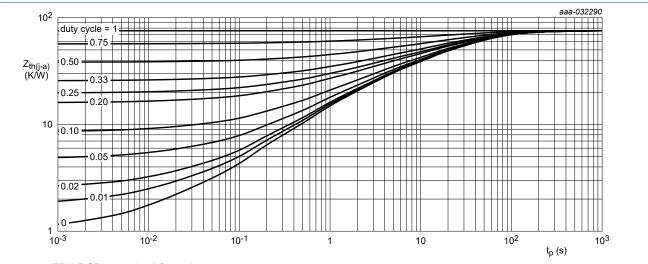
- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
junction to ambient	junction to ambient		[1] [3]	-	-	70	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	7	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

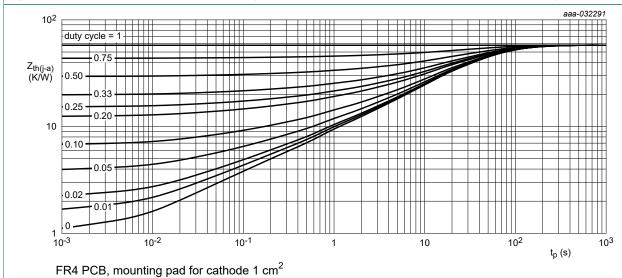


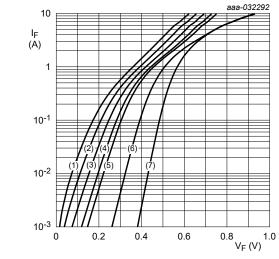
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I _R = 1 mA; T _j = 25 °C	[1]	100	-	-	V
V _F	forward voltage	I _F = 0.5 A; pulsed; T _j = 25 °C	[1]	-	460	560	mV
		I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	510	580	mV
		I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	580	650	mV
		I _F = 3 A; pulsed; T _j = 25 °C	[1]	-	650	710	mV
		I _F = 5 A; pulsed; T _j = 25 °C	[1]	-	750	810	mV
		I _F = 5 A; pulsed; T _j = -40 °C	[1]	-	755	820	mV
		I _F = 5 A; pulsed; T _j = 125 °C	[1]	-	620	690	mV
		$I_F = 5 \text{ A}$; pulsed; $T_j = 150 \text{ °C}$	[1]	-	580	660	mV
I _R	reverse current	V _R = 60 V; pulsed; T _j = 25 °C	[1]	-	0.15	0.63	μΑ
		V_R = 100 V; pulsed; T_j = 25 °C	[1]	-	0.4	2.5	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.6	3	mA
		V _R = 100 V; pulsed; T _j = 150 °C	[1]	-	2.3	12	mA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	410	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	120	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	12	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	12	-	ns
I _{RM}	peak reverse recovery current	$dI_F/dt = 200 \text{ A/s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	1.3	-	Α
Q _{rr}	reverse recovery charge			-	9.5	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}$; $dI_F/dt = 20 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$		-	460	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

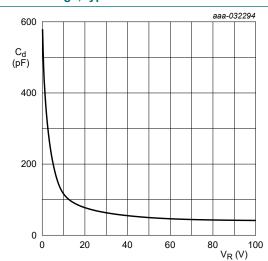
(3) Tj = 125 °C

(4) Tj = 100 °C

(5) Tj = 85 °C (6) Tj = 25 °C

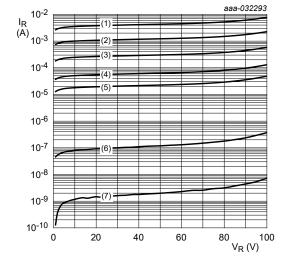
(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



pulsed condition

(1) $T_i = 175 \,^{\circ}\text{C}$

 $(2) T_i = 150 °C$

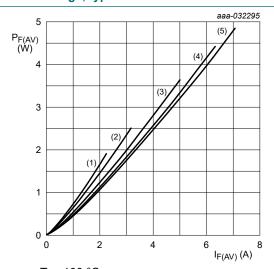
 $(3) T_j = 125 °C$

 $(4) T_j = 100 °C$

(5) $T_j = 85 ^{\circ}C$ (6) $T_i = 25 ^{\circ}C$

 $(7) T_{j} = -40 ^{\circ}C$

Fig. 4. Reverse current as a function of reverse voltage; typical values



T_j = 100 °C

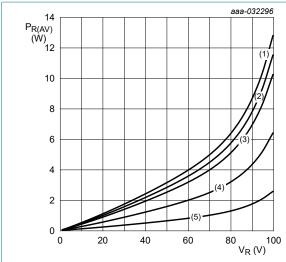
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

(4) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



T_j = 100 °C

 $(1) \delta = 1$; DC

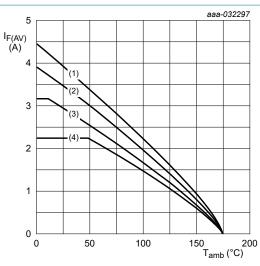
 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$

 $(5) \delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

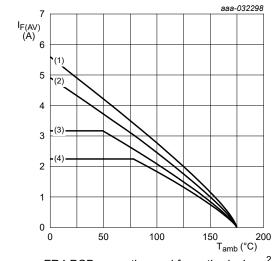
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

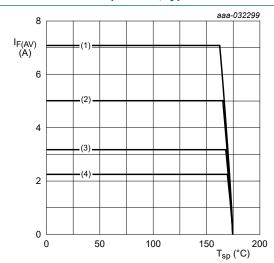
(1) $\delta = 1$; DC

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1) δ = 1; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

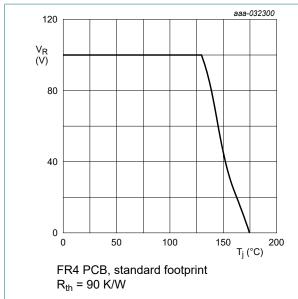
(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

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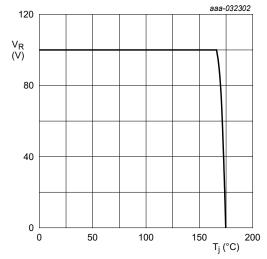
100 V, 5 A low leakage current Trench MEGA Schottky barrier rectifier



120 V_R (V) 80 40 50 100 FR4 PCB, mounting pad for cathode 1 cm² $R_{th} = 70 \text{ K/W}$

of junction temperature; typical values

Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



Soldering point of cathode tab $R_{th} = 7 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

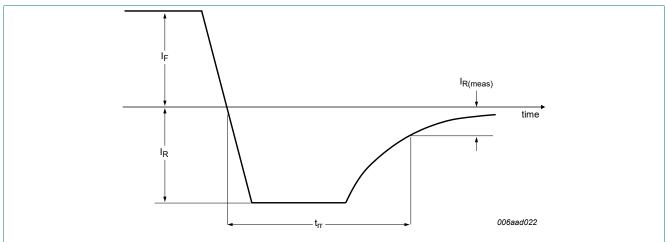


Fig. 14. Reverse recovery definition; step recovery

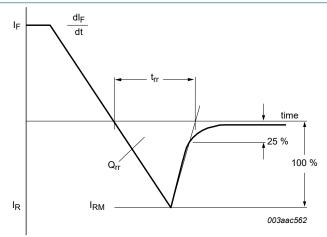


Fig. 15. Reverse recovery definition; ramp recovery

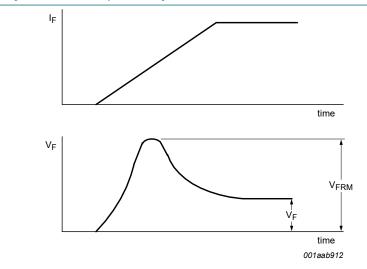
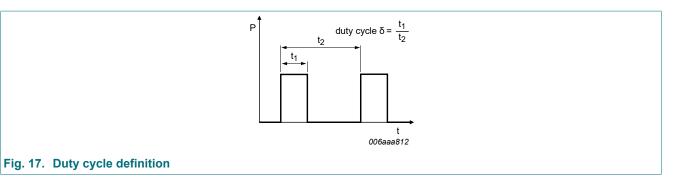


Fig. 16. Forward recovery definition

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The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)}=I_M\times\delta$ with I_M defined as peak current

 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

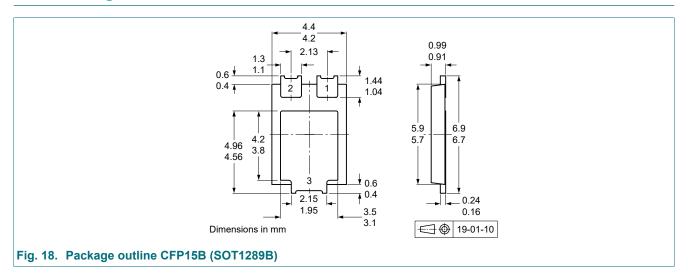
with $I_{\mbox{\scriptsize RMS}}$ defined as RMS current.

Quality information

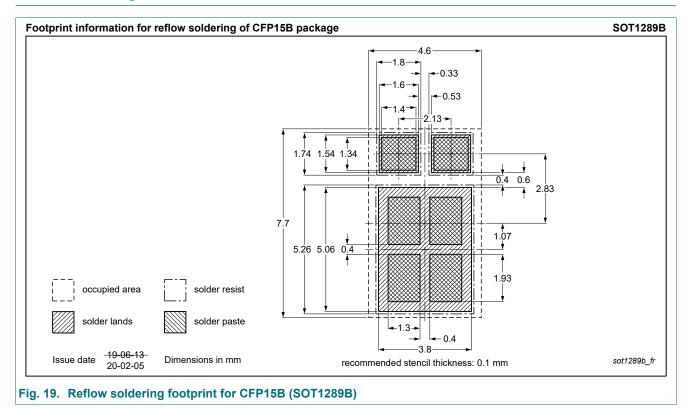
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG100T050ELPE v.2	20201203	Product data sheet	-	PMEG100T050ELPE v.1
Modifications:	Product status of	changed		
PMEG100T050ELPE v.1	20201019	Preliminary data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Date of release: 3 December 2020

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